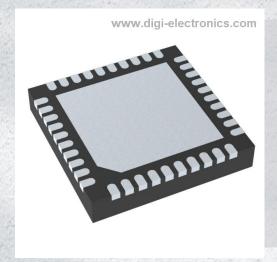


LE9541CUQC Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number LE9541CUQC-DG

Manufacturer Microchip Technology

Manufacturer Product Number LE9541CUQC

Description IC TELECOM INTERFACE 40QFN

Detailed Description Telecom IC Subscriber Line Interface Concept (SLIC

) 40-QFN



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8542.39.0001

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
LE9541CUQC	Microchip Technology
Series:	Product Status:
	Active
Function:	Interface:
Subscriber Line Interface Concept (SLIC)	Serial
Number of Circuits:	Voltage - Supply:
1	3.3V
Current - Supply:	Operating Temperature:
Mounting Type:	Package / Case:
Surface Mount	
Supplier Device Package:	Base Product Number:
40-QFN	LE9541

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	3 (168 Hours)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

Le9541/51



Ringing Subscriber Line Interface Circuit VE950 Series

Product Brief

Features

- Optimized to work with BCM338x/BCM339x Broadcom SoCs for short loop residential gateways
- Single Channel High Voltage Ringing SLIC that is functionally equivalent to one channel of the Le9540.
- Le9541 is available in a 6x6 40-pin QFN package that is "pin-to-pin" compatible with (channel 1 of) Le9540 which enables a dual one or two channel PCB Design.
- Le9551 is available in a 4x5 28-pin QFN that is optimized for single channel applications
- High Voltage High Bandwidth Design Supports 7-kHz Wide Band Applications
 - Up to -145 V ringing battery Le9541/51D
 - Up to -100 V ringing battery Le9541/51C
- Operation Control and Status Report through Serial Interface with Reset
- Supports GR909 Testing
- DC Loop Closure/Ring Trip/Thermal Shut-down
- Loop Start, Ring Trip, and Ring-Ground Detections with Two Thresholds
- Thermal Shut down Protection with Hysteresis
- Test Load Switch Supports Integrated Test Algorithms

Description

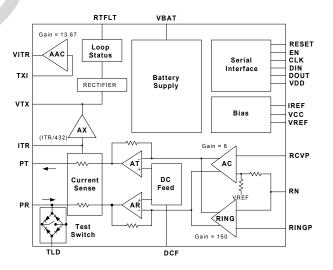
The Le9541 Ringing SLIC device is a single-channel device and equivalent of channel 1 of the Le9540. It is offered in the same 6x6 40-pin QFN package as the Le9540 to enable a "dual" one or two channel PCB design. The Le9551 is also the equivalent of one channel of the Le9540. It is offered in a small 4x5 28-pin QFN, and is optimized for a single channel application. These devices provide battery feed, ringing, and supervision on voice loops found in short-loop Cable applications. These devices are optimized to interface to the Broadcom BCM338x or BCM339x families of SoCs. Operational control and status report are communicated through a serial interface with reset. These devices support wide-band applications and GR909 testing.

Document ID# 153225	Version 2	February 2016

Ordering Information						
Le9541CUQC	40-pin QFN	Tray				
Le9541DUQC	40-pin QFN	Tray				
Le9541CUQCT	40-pin QFN	Tape and Reel				
Le9541DUQCT	40-pin QFN	Tape and Reel				
Le9551CMQC	28-pin QFN	Tray				
Le9551DMQC	28-pin QFN	Tray				
Le9551CMQCT	28-pin QFN	Tape and Reel				
Le9551DMQCT	28-pin QFN	Tape and Reel				

All devices are in green package. The green package meets RoHS 2 Directive 2011/65/EU of the European Council to minimize the environmental impact of electrical equipment.

Block Diagram



Pin Assignment

Figure 1 - 40 Pin 6x6mm QFN

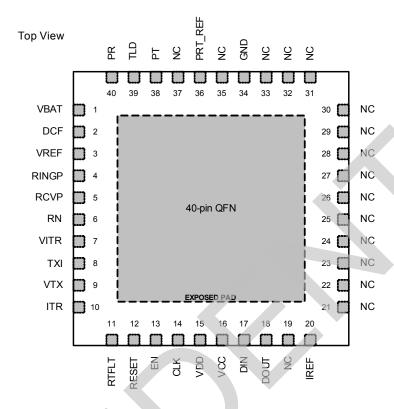
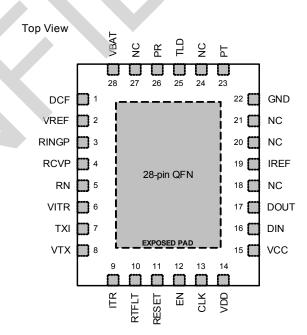


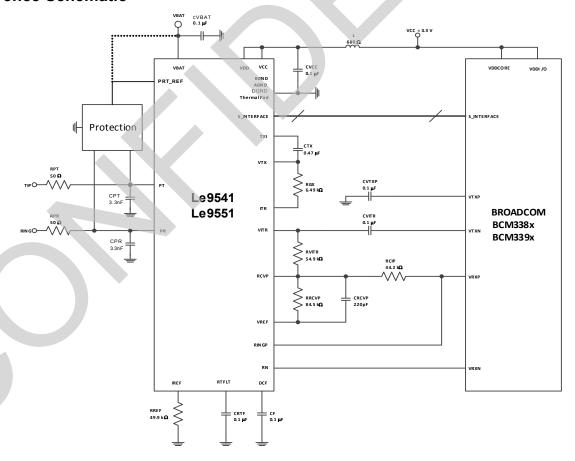
Figure 2 - 28 Pin 4x5mm QFN



Selected Electrical Specifications

Parameter	Min.	Тур.	Max.	Unit
Power Scan state, V _{BAT} = -60 V	_	30	36	mW
Power Active state, Forward/Reverse, V _{BAT} = -60 V	_	96	107	mW
Ring state, no load, V _{BAT} = -100 V (Le9541/51C)	_	211	236	mW
Ring state, no load, V _{BAT} = -145 V (Le9541/51D)	_	312	359	mW
Longitudinal to Metallic Balance at Tip/Ring	52	_		dB
PSRR VBAT 500Hz to 3000Hz (Active Modes)	40	_		dB
Gain vs. Frequency (transmit and receive), 600 Ω				
Termination, 1004 Hz, 1020 Hz Reference (typ):				
150 Hz to 300 Hz	-3.0	0	0.05	
300 Hz to 6.4 kHz	-1.0	0	0.05	dB
6.4 kHz to 6.8 kHz	-3.0	0	0.05	

Reference Schematic



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